

# **DAITAC Adhesive Tapes for Flexible Printed Circuits**

who can access the strongest tapes for bonding flexible printed circuits?

you can.

working for you.





## DIC's DAITAC Double-Sided Adhesive Tapes for Flexible Printed Circuits

### Key Attributes and Benefits:

- Double-sided adhesive tapes from the DIC Corporation deliver exceptional adhesion and holding strength to various materials
- Superior repulsion resistance
- Available in varieties that deliver outstanding static sheer
- Samples are available for testing

### **Major Applications:**

- Durable bonding for flexible printed circuits (FPCs) in electronics
- Reliable bonding of bent substrates

| DAITAC Adhesion Values |        |       |       |        |  |
|------------------------|--------|-------|-------|--------|--|
|                        | Units  | FRT30 | FRT50 | FRT100 |  |
| Tape Thickness         | μm     | 30    | 50    | 100    |  |
| Adhesion to SUS        |        | 9     | 11    | 15     |  |
| Adhesion to Pl         |        | 10    | 11    | 15     |  |
| Adhesion to PC         | N/20mm | 10    | 12    | 16     |  |
| Adhesion to ABS        |        | 12    | 13    | 18     |  |
| Adhesion to Glass      |        | 9     | 11    | 15     |  |

#### **DAITAC Adhesion Values**



#### Adhesion Test Method



Angle: 180deg. Speed: 300mm/min

# Developed by DIC. Delivered by Sun.

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| DAITAC Reliability Results |       |       |        |  |  |
|----------------------------|-------|-------|--------|--|--|
| Condition                  | FRT30 | FRT50 | FRT100 |  |  |
| Initial (23°C/50%RHx1h)    | 9     | 11    | 15     |  |  |
| 23°C/50%RHx500h            | 13    | 15    | 24     |  |  |
| 85°Cx500h                  | 20    | 22    | 32     |  |  |
| -35°Cx500h                 | 12    | 13    | 18     |  |  |
| 60°C/90%RHx500h            | 18    | 20    | 24     |  |  |
| 85°C <-> -35°Cx100cycles   | 20    | 20    | 29     |  |  |

\*Adhesion to SUS [N/20mm]

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